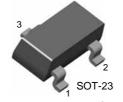


MMBT2907AK

PNP Epitaxial Silicon Transistor

General Purpose Transistor





1. Base 2. Emitter 3. Collector

Absolute Maximum Ratings $T_a = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	-60	V
V _{CEO}	Collector-Emitter Voltage	-60	V
V _{EBO}	Emitter-Base Voltage	-5	V
I _C	Collector Current	-600	mA
P _C	Collector Power Dissipation		mW
T _{J,} T _{STG}	Operating Junction and Storage Temperature Range -55 ~ 150		°C

Electrical Characteristics T_a=25°C unless otherwise noted

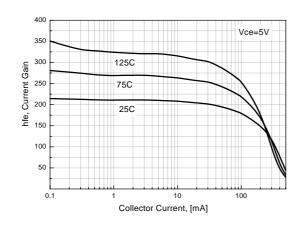
Symbol	Parameter	Test Condition	Min.	Max.	Units
BV _{CBO}	Collector-Base Breakdown Voltage	$I_{\rm C} = -10\mu A, I_{\rm E} = 0$	-60		V
BV _{CEO}	Collector-Emitter Breakdown Voltage *	$I_{\rm C} = -10 {\rm mA}, I_{\rm B} = 0$	-60		V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_{E} = -10 \mu A, I_{C} = 0$	-5		V
I _{CBO}	Collector Cut-off Current	$V_{CB} = -50V, I_E = 0$		-0.01	μA
h _{FE}	DC Current Gain	$ \begin{array}{l} V_{CE} = -10V, \ I_{C} = -0.1mA \\ V_{CE} = -10V, \ I_{C} = -1.0mA \\ V_{CE} = -10V, \ I_{C} = -10mA \\ V_{CE} = -10V, \ I_{C} = -150mA \\ * \\ V_{CE} = -10V, \ I_{C} = -500mA \\ \end{array} $	75 100 100 100 50	300	
V _{CE} (sat)	Collector-Emitter Saturation Voltage *	$I_{C} = -150$ mA, $I_{B} = -15$ mA $I_{C} = -500$ mA, $I_{B} = -50$ mA		-0.4 -1.6	V V
V _{BE} (sat)	Base-Emitter Saturation Voltage *	I _C = -150mA, I _B = -15mA I _C = -500mA, I _B = -50mA		-1.3 -2.6	V V
f _T	Current Gain Bandwidth Product	I _C = -50mA, V _{CE} = -20V, f = 100MHz	200		MHz
C _{ob}	Output Capacitance	$V_{CB} = -10V, I_E = 0, f = 1.0MHz$		8	pF
t _{ON}	Turn On Time	V _{CC} = -30V, I _C = -150mA 50 I _{B1} = -15mA		50	ns
t _{OFF}	Turn Off Time	$V_{CC} = -6V, I_C = -150mA$ 110 $I_{B1} = I_{B2} = -15mA$		ns	

* Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%

Typical Performance Characteristics

Figure 1. DC current Gain

Figure 2. Collector-Emitter Saturation Voltage



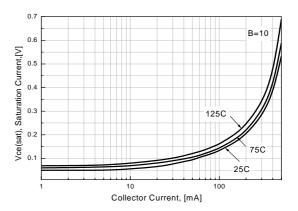


Figure 3. Base-Emitter Saturation Voltage

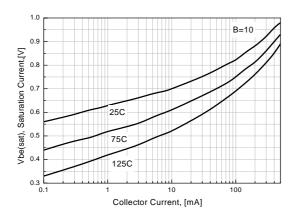


Figure 5. Output Capacitance

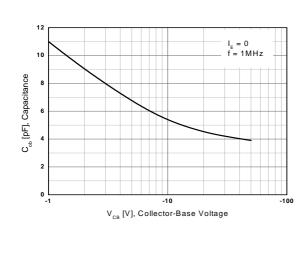


Figure 4. Collector - Base Leakage Current

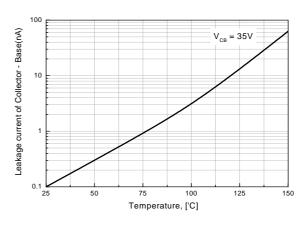
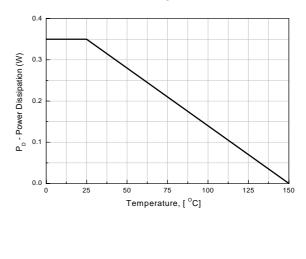
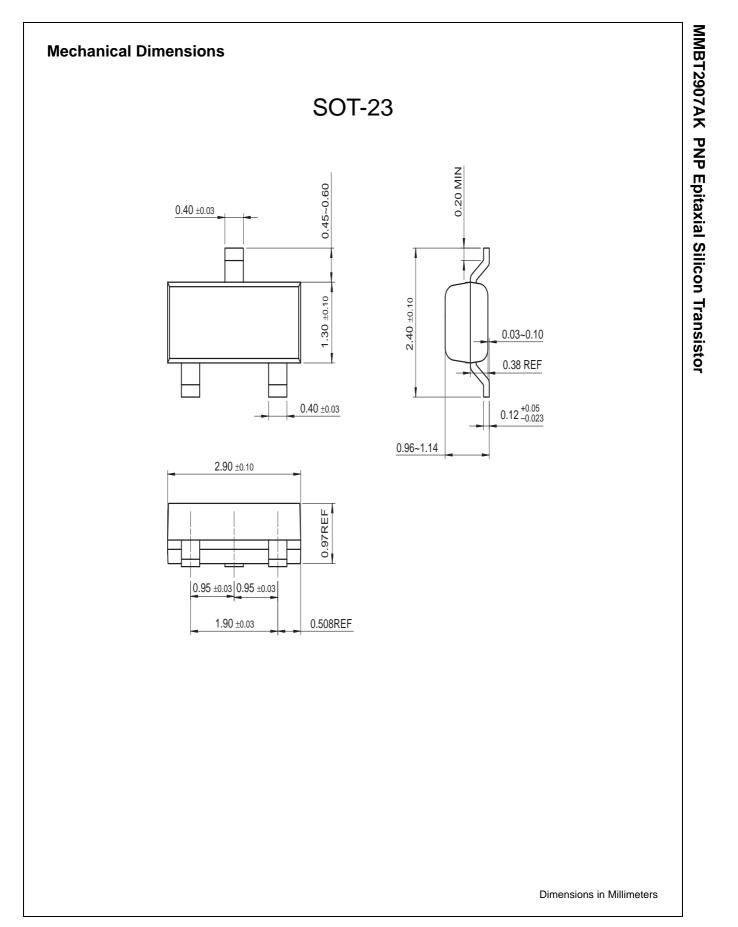


Figure 6. Power Dissipation vs Ambient Temperature





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